

INFRARED EMITTING DIODE

Part Number: AM2520F3C03

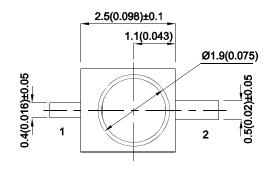
Features

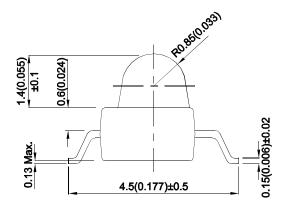
- Subminiature package.
- Mechanically and spectrally matched to the phototransistor.
- Gull wing lead.
- Long life solid state reliability.
- Low package profile.
- Package: 1000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

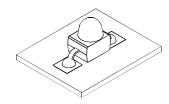
Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

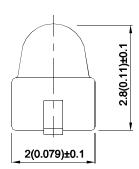
Package Dimensions











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- All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 5. The device has a single mounting surface. The device must be mounted according to the specifications.

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CHECKED: Allen Liu

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	Po (mW/sr) [2] @ 20mA		Po (mW/sr) [2] @ 50mA		Viewing Angle [1]
			Min.	Тур.	Min.	Тур.	201/2
AM2520F3C03	Infrared (GaAs)	Water Clear	5	10	10	20	- 20°
			*3	*8	*8	*16	

Notes:

- $1. \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Radiant Intensity / luminous flux: +/-15%.
 Radiant intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Parameter	Emitting Color	Symbol	Тур.	Max.	Units	Test Conditions	
Forward Voltage [1]	F3	VF	1.2	1.6	V	I==20mA	
Reverse Current	F3	lr		10	uA	VR = 5V	
Capacitance	F3	С	90		pF	VF=0V;f=1MHz	
Peak Spectral Wavelength	F3	λP	940		nm	IF=20mA	
Spectral Bandwidth	F3	Δλ1/2	50		nm	IF=20mA	

Notes:

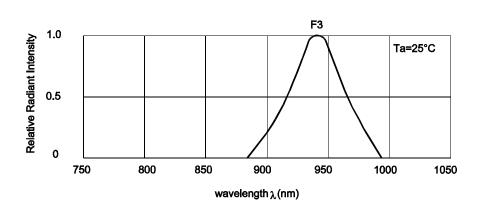
- 1.Forward Voltage: +/-0.1V.
 2.Wavelength value is traceable to CIE127-2007 standards.
 3.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Values	Units
Power dissipation	PD	80	mW
DC Forward Current	lF	50	mA
Peak Forward Current [1]	iFS	1.2	А
Reverse Voltage	VR	5	V
Operating Temperature	Та	-40 To +85	°C
Storage Temperature	Тѕтс	-40 To +85	°C

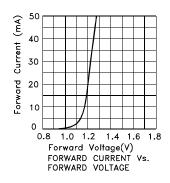
- 1. 1/100 Duty Cycle, 10µs Pulse Width.
 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

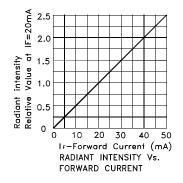
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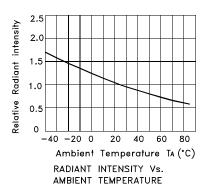


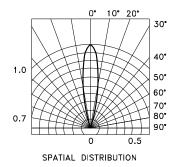
Relative Intensity Vs. Wavelength

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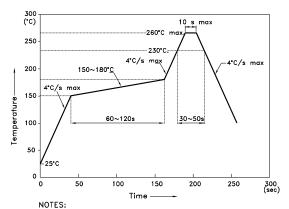
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



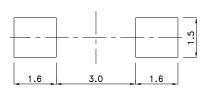
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

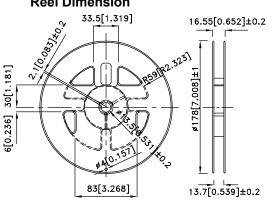
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

 3.Number of reflow process shall be 2 times or less.

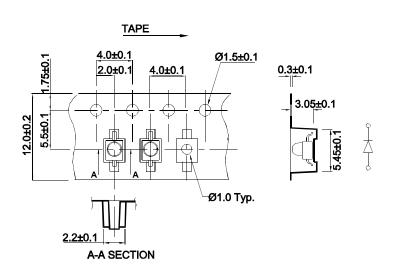
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



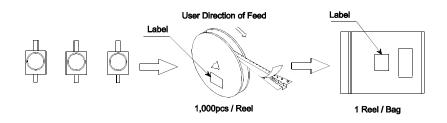
Tape Specifications (Units: mm)

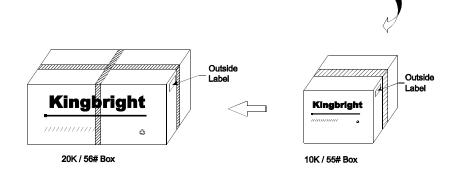


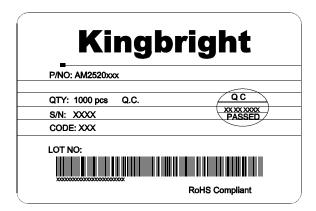
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PACKING & LABEL SPECIFICATIONS

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